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Applicant	:	Paul A. Farrar
Appl. No.	:	09/909, 181
Filed	:	July 19, 2001
For	:	METHOD OF USING FOAMED INSULATORS IN THREE DIMENSIONAL MULTICHIP STRUCTURES
Examiner	:	Chris C. Chu

I hereby certify that this correspondence and all marked attachments are being deposited with the United States Postal Service as first-class mail in an envelope addressed to: United States Patent and Trademark Office, P.O. Box 2327, Arlington, VA 22202 on

~~April 5, 2009~~
(Date)

Michael H. Trenholm, Reg. No. 37,743

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Assistant Commissioner for Patents
Washington, D.C. 20231

In response to the Restriction Requirement mailed March 15, 2002, the Applicant hereby elects Claim Group I (i.e., Claims 1-26). By this paper, Applicant hereby cancels Claims 27-32, without prejudice. The Applicant believes that the application is now in condition for examination on the merits and requests the prompt examination of the same. Should there be any impediment to the prompt examination of this application that could be resolved by a telephone conference, the Examiner is respectfully requested to call the undersigned at the number shown below.

Appl. No. : 909, 181
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Please charge any additional fees, including any fees for additional extension of time, or credit overpayment to Deposit Account No. 11-1410.

Respectfully submitted,

KNOBBE, MARTENS, OLSON & BEAR, LLP

Dated: 

By: 

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